Product Preview

Hex Differential Line Receiver

The MC10EP116/100EP116 is a 6-bit differential line receiver based on the EP16 device. The 3.0GHz bandwidth provided by the high frequency outputs makes the device ideal for buffering of very high speed oscillators.

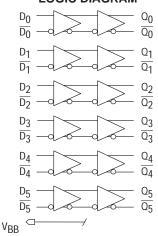
A V_{BB} pin is available to AC couple an input signal to the device. More information on AC coupling can be found in the design handbook interfacing with ECLinPS on our website.

The design incorporates two stages of gain, internal to the device, making it an excellent choice for use in high bandwidth amplifier applications.

The differential inputs have internal clamp structures which will force the Q output of a gate in an open input condition to go to a LOW state. Thus, inputs of unused gates can be left open and will not affect the operation of the rest of the device. Note that the input clamp will take affect only if both inputs fall 2.5V below VCC. All VCC and VEE pins must be externally connected to power supply to guarantee proper operation.

- 230ps Typical Propagation Delay
- High Bandwidth to 3.0 GHz Typical
- PECL mode: 3.0V to 5.5V V_{CC} with $V_{EE} = 0V$
- ECL mode: 0V V_{CC} with $V_{EE} = -3.0V$ to -5.5V
- Internal Input Resistors: Pulldown on D, Pulldown and Pullup on \overline{D}
- Q Output will default LOW with inputs open or at VEE
- ESD Protection: 2KV HBM, 100V MM
- VBB Output
- New Differential Input Common Mode Range
- Moisture Sensitivity Level 2
 For Additional Information, See Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count: 729 devices

LOGIC DIAGRAM



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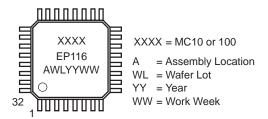
Formerly a Division of Motorola

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32-LEAD TQFP FA SUFFIX CASE 873A

MARKING DIAGRAM*



*For additional information, see Application Note AND8002/D

PIN DESCRIPTION								
PIN	FUNCTION							
D[0:5], D[0:5]	ECL Differential Data Inputs							
Q[0:5], Q[0:5]	ECL Differential Data Outputs							
VBB	Reference Voltage Output							
VCC	Positive Supply							
VEE	Negative, 0 Supply							

ORDERING INFORMATION

Device	Package	Shipping
MC10EP116FA	TQFP	250 Units/Tray
MC10EP116FAR2	TQFP	2000 Tape & Reel
MC100EP116FA	TQFP	250 Units/Tray
MC100EP116FAR2	TQFP	2000 Tape & Reel

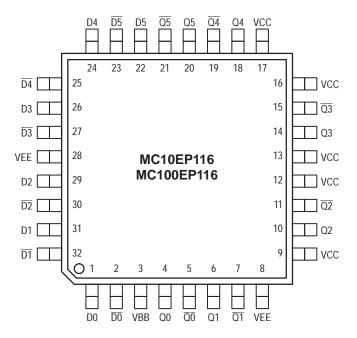


Figure 1. 32-Lead LQFP Pinout (Top View)

Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

MAXIMUM RATINGS*

Symbol	Parameter		Value	Unit			
VEE	Power Supply (V _{CC} = 0V)	-6.0 to 0	VDC				
VCC	Power Supply (VEE = 0V)		6.0 to 0	VDC			
VI	Input Voltage (V _{CC} = 0V, V _I not more negative than	Input Voltage (V _{CC} = 0V, V _I not more negative than V _{EE})					
VI	Input Voltage (VEE = 0V, VI not more positive than \	6.0 to 0	VDC				
l _{out}	Output Current	Continuous Surge	50 100	mA			
I _{BB}	V _{BB} Sink/Source Current†		± 0.5	mA			
TA	Operating Temperature Range		-40 to +85	°C			
T _{stg}	Storage Temperature		-65 to +150	°C			
θ JA	Thermal Resistance (Junction-to-Ambient)	Still Air 500lfpm	80 55	°C/W			
θЈС	Thermal Resistance (Junction-to-Case)		12 to 17	°C/W			
T _{sol}	Solder Temperature (<2 to 3 Seconds: 245°C desire	d)	265	°C			

^{*} Maximum Ratings are those values beyond which damage to the device may occur.

[†] Use for inputs of same package only.

DC CHARACTERISTICS, ECL/LVECL ($V_{CC} = 0V$; $V_{EE} = -5.5V$ to -3.0V) (Note 4.)

			-40°C 25°C								
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current (Note 1.)					80					mA
VOH	Output HIGH Voltage (Note 2.)	-1135	-1060	-885	-1070	-945	-820	-1010	-885	-760	mV
VOL	Output LOW Voltage (Note 2.)	-1935	-1810	-1685	-1870	-1745	-1620	-1810	-1685	-1560	mV
VIH	Input HIGH Voltage Single Ended	-1210		-885	-1145		-820	-1085		-760	mV
V _{IL}	Input LOW Voltage Single Ended	-1935		-1610	-1870		-1545	-1810		-1485	mV
V _{BB}	Output Voltage Reference	-1510	-1410	-1310	-1445	-1345	-1245	-1385	-1285	-1185	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Note 3.)	VEE	+2.0	0.0	VEE	+2.0	0.0	VEE	+2.0	0.0	V
lН	Input HIGH Current			150			150			150	μА
IIL	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μА

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

1. V_{CC} = 0V, V_{EE} = V_{EEmin} to V_{EEmax}, all other pins floating.

2. All loading with 50 ohms to V_{CC}-2.0 volts.

3. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.

4. Input and output parameters vary 1:1 with V_{CC}.

DC CHARACTERISTICS, LVPECL ($V_{CC} = 3.3V \pm 0.3V$, $V_{EE} = 0V$) (Note 8.)

			-40°C 25°C								
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current (Note 5.)					80					mA
VOH	Output HIGH Voltage (Note 6.)	2165	2240	2415	2230	2355	2480	2290	2415	2540	mV
VOL	Output LOW Voltage (Note 6.)	1365	1490	1615	1430	1555	1680	1490	1615	1740	mV
VIH	Input HIGH Voltage Single Ended	2090		2415	2155		2480	2215		2540	mV
V _{IL}	Input LOW Voltage Single Ended	1365		1690	1430		1755	1490		1815	mV
V _{BB}	Output Voltage Reference	1790	1890	1990	1855	1955	2055	1915	2015	2115	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Note 7.)	2.0		3.3	2.0		3.3	2.0		3.3	V
lН	Input HIGH Current			150			150			150	μΑ
Iμ	Input LOW Current $\frac{D}{\overline{D}}$	0.5 -150			0.5 -150			0.5 -150			μА

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

- V_{CC} = 3.0V, V_{EE} = 0V, all other pins floating.
 All loading with 50 ohms to V_{CC}-2.0 volts.
 V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}.
 Input and output parameters vary 1:1 with V_{CC}.

DC CHARACTERISTICS, PECL ($V_{CC} = 5.0V \pm 0.5V$, $V_{EE} = 0V$) (Note 12.)

			-40°C	-40°C 25°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
IEE	Power Supply Current (Note 9.)					80					mA
VOH	Output HIGH Voltage (Note 10.)	3865	3940	4115	3930	4055	4180	3990	4115	4240	mV
VOL	Output LOW Voltage (Note 10.)	3065	3190	3315	3130	3255	3380	3190	3315	3440	mV
VIH	Input HIGH Voltage Single Ended	3790		4115	3855		4180	3915		4240	mV
V _{IL}	Input LOW Voltage Single Ended	3065		3390	3130		3455	3190		3515	mV
V_{BB}	Output Voltage Reference	3490	3590	3690	3555	3655	3755	3615	3715	3815	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Note 11.)	2.0		5.0	2.0		5.0	2.0		5.0	V
lн	Input HIGH Current			150			150			150	μΑ
IIL	Input LOW Current DDD	0.5 -150			0.5 -150			0.5 -150			μА

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

AC CHARACTERISTICS ($V_{CC} = 0V$; $V_{EE} = -3.0V$ to -5.5V) or ($V_{CC} = 3.0V$ to 5.5V; $V_{EE} = 0V$)

		–40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
fmax	Maximum Toggle Frequency (Note 13.)					3.0					GHz
tPLH, tPHL	Propagation Delay to Output Differential					230					ps
tSKEW	Duty Cycle Skew (Note 14.)		5.0			5.0	20		5.0	20	ps
^t JITTER	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
V _{PP}	Input Voltage Swing (Diff.)	150	800	1200	150	800	1200	150	800	1200	mV
t _r t _f	Output Rise/Fall Times Q (20% – 80%)					130					ps

^{9.} V_{CC} = 5.0V, V_{EE} = 0V, all other pins floating. 10. All loading with 50 ohms to V_{CC} -2.0 volts.

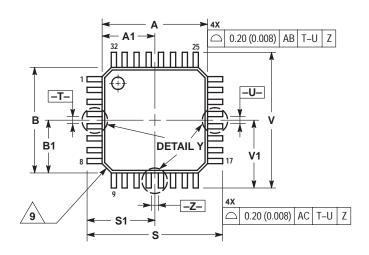
^{11.} V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . 12. Input and output parameters vary 1:1 with V_{CC} .

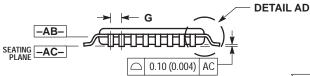
^{13.}F_{max} guaranteed for functionality only. V_{OL} and V_{OH} levels are guaranteed at DC only.
14. Skew is measured between outputs under identical transitions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.

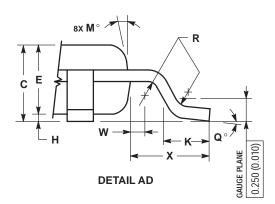
PACKAGE DIMENSIONS

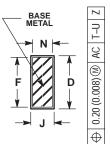
TQFP FA SUFFIX

32-LEAD PLASTIC PACKAGE CASE 873A-02 ISSUE A

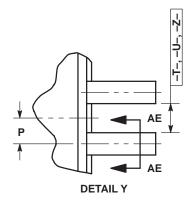








SECTION AE-AE



NOTES:

- 11. DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DATUM PLANE -AB- IS LOCATED AT BOTTOM
 OF LEAD AND IS COINCIDENT WITH THE LEAD
 WHERE THE LEAD EXITS THE PLASTIC BODY AT
 THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -T., -U., AND -Z. TO BE
 DETERMINED AT DATUM PLANE -AB-.
 5. DIMENSIONS S AND Y TO RE DETERMINED AT
 5. DIMENSIONS S AND Y TO RE DETERMINED AT
- 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE –AC–.
- SEATING PLANE -AC-.
 6. DIMENSIONS A AND B DO NOT INCLUDE
 MOLD PROTRUSION. ALLOWABLE PROTRUSION
 IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B
- DO INCLUDE MOLD MISMATCH AND ARE
 DETERMINED AT DATUM PLANE -AB-.
 TO DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.520 (0.020).
- U.S.Z. (U.U.Z.).

 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).

 9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

	MILLIN	METERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
Α	7.000	BSC	0.276	BSC		
A1	3.500	BSC	0.138	BSC		
В	7.000	BSC	0.276	BSC		
B1	3.500	BSC	0.138	BSC		
С	1.400	1.600	0.055	0.063		
D	0.300	0.450	0.012	0.018		
Ε	1.350	1.450	0.053	0.057		
F	0.300	0.400	0.012	0.016		
G	0.800	BSC	0.031	BSC		
Н	0.050	0.150	0.002	0.006		
J	0.090	0.200	0.004	0.008		
K	0.500	0.700	0.020	0.028		
M	12°	REF	12° REF			
N	0.090	0.160	0.004	0.006		
P	0.400		0.016	BSC		
Q	1°	5°	1°	5°		
R	0.150	0.250	0.006	0.010		
S	9.000	BSC	0.354	BSC		
S1	4.500	BSC	0.177	BSC		
V	9.000	BSC	0.354 BSC			
V1	4.500	BSC	0.177 BSC			
W	0.200	REF	0.008	REF		
Х	1.000	REF	0.039	REF		





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